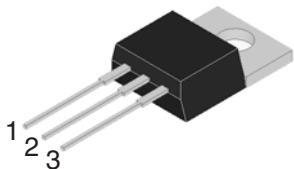
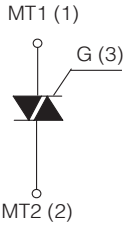




## INSULATED HIGH COMMUTATION TRIAC

|   |  |                                   |   |   |  |
|---|--|-----------------------------------|---|---|--|
| <p style="text-align: center; font-weight: bold; font-size: 1.2em;">INSULATED TO-220AB</p> <div style="text-align: center; margin-top: 20px;">  </div> <div style="text-align: center; margin-top: 20px;">  </div> | <table style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 50%; text-align: center;"><b>On-State Current</b><br/>12 Amp</td> <td style="width: 50%; text-align: center;"><b>Gate Trigger Current</b><br/>≤ 50 mA (16)<br/>≤ 35 mA (14)</td> </tr> <tr> <td colspan="2" style="text-align: center;"><b>Off-State Voltage</b><br/>400 V ÷ 800 V</td> </tr> </table> <p><b>FEATURES</b></p> <ul style="list-style-type: none"> <li>Provides voltage insulated tab (rated at 2500V RMS)</li> <li>Glass/passivated die junctions</li> <li>Medium current Triac</li> <li>Low thermal resistance</li> <li>High commutation</li> <li>High surge current capability</li> <li>Low forward voltage drop</li> <li>Solder dip 260°C, 10s</li> <li>Component in accordance to RoHS 2011/65/EU and WEEE 2002/96/EC</li> <li>Meets MSL level 3, per J-STD-020, LF maximum peak of 260° C</li> <li>Certified compliance of UL 1557 Standard for Electrically Isolated Semiconductors. Fille reference E320541, Vol. 3</li> </ul> <p style="text-align: right;"> <br/> <br/> <b>RoHS COMPLIANT</b> </p> <p><b>MECHANICAL DATA</b></p> <ul style="list-style-type: none"> <li><b>Case:</b> INSULATED TO-220AB. Epoxy meets UL 94V-0 flammability rating.</li> <li><b>Polarity:</b> As marked on the body.</li> <li><b>Terminals:</b> Matte tin plated leads, solderable per MIL-STD-750 Method 2026, J-STD-002 and JESD22-B102. Consumer grade, meets JESD 201 class 1A whisker test.</li> </ul> <p><b>TYPICAL APPLICATIONS</b></p> <ul style="list-style-type: none"> <li>Used on inductive loads, thanks to their high commutation performances.</li> </ul> | <b>On-State Current</b><br>12 Amp | <b>Gate Trigger Current</b><br>≤ 50 mA (16)<br>≤ 35 mA (14) | <b>Off-State Voltage</b><br>400 V ÷ 800 V |  |
| <b>On-State Current</b><br>12 Amp   | <b>Gate Trigger Current</b><br>≤ 50 mA (16)<br>≤ 35 mA (14)  |                                   |   |   |  |
| <b>Off-State Voltage</b><br>400 V ÷ 800 V   |  |                                   |   |   |  |

### Maximun Ratings and Electrical Characteristics at 25°C

| SYMBOL       | PARAMETER   | CONDITIONS   | Value      | Unit             |
|--------------|---|--|------------|------------------|
| $I_{T(RMS)}$ | RMS On-state Current (full sine wave)                 | All Conduction Angle, $T_c = 90^\circ C$                                   | 12         | A                |
| $I_{TSM}$    | Non-repetitive On-State Current                       | Full Cycle, 60 Hz ( $t = 16.7$ ms)   | 125        | A                |
| $I_{TSM}$    | Non-repetitive On-State Current                       | Full Cycle, 50 Hz ( $t = 20$ ms)   | 120        | A                |
| $I^2t$       | Fusing Current  | $t_p = 10$ ms, Half Cycle  | 72         | A <sup>2</sup> s |
| $I_{GM}$     | Peak Gate Current                                     | 20 $\mu$ s max. $T_j = 125^\circ C$  | 4          | A                |
| $P_{G(AV)}$  | Average Gate Power Dissipation                        | $T_j = 125^\circ C$  | 1          | W                |
| $di/dt$      | Critical rate of rise of on-state current             | $I_G = 2x I_{GT}$ , $t_r \leq 100$ ns<br>$f = 120$ Hz, $T_j = 125^\circ C$ | 50         | A/ $\mu$ s       |
| $T_j$        | Operating Temperature                                 |  | (-40 +125) | °C               |
| $T_{stg}$    | Storage Temperature                                   |  | (-40 +125) | °C               |
| $T_{sld}$    | Soldering Temperature                                 | 10s max  | 260        | °C               |
| $V_{iso}$    | R.M.S. isolation voltage 50/60 Hz sinusoidal waveform |  | 2.500      | Vac              |

| SYMBOL            | PARAMETER                         | VOLTAGE |     |     | Unit |
|-------------------|-----------------------------------|---------|-----|-----|------|
|                   |                                   | D       | M   | N   |      |
| $V_{DRM}/V_{RRM}$ | Repetitive Peak Off State Voltage | 400     | 600 | 800 | V    |

## INSULATED HIGH COMMUTATION TRIAC

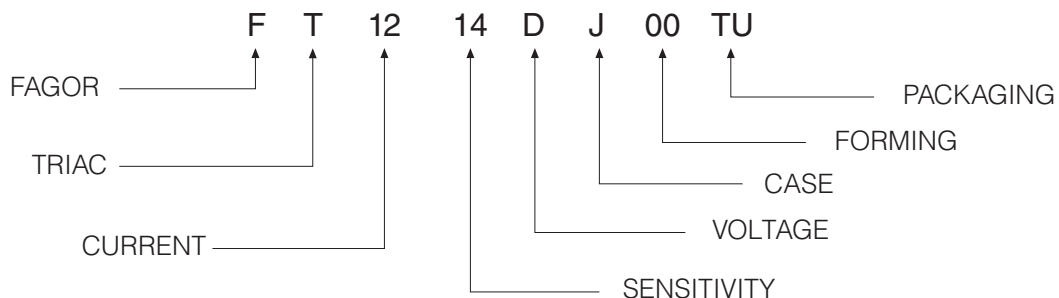
### Electrical Characteristics at Tamb = 25 °C

| SYMBOL            | PARAMETER                              | CONDITIONS   | Quadrant |     | SENSITIVITY |      | Unit       |
|-------------------|--|--|----------|-----|-------------|------|------------|
|                   |  |  |          |     | 14          | 16   |            |
| $I_{GT}^{(1)}$    | Gate Trigger Current                   | $V_D = 12 V_{DC}, R_L = 33\Omega, T_j = 25\text{ °C}$  | Q1÷Q3    | MAX | 35          | 50   | mA         |
| $V_{GT}$          | Gate Trigger Voltage                   | $V_D = 12 V_{DC}, R_L = 33\Omega, T_j = 25\text{ °C}$  | Q1÷Q3    | MAX | 1.3         |      | V          |
| $V_{GD}$          | Gate Non Trigger Voltage               | $V_D = V_{DRM}, R_L = 3.3\text{ K}\Omega, T_j = 125\text{ °C}$   | Q1÷Q3    | MIN | 0.2         |      | V          |
| $I_H^{(2)}$       | Holding Current                        | $I_T = 500\text{ mA}, \text{Gate open}, T_j = 25\text{ °C}$  |          | MAX | 35          | 50   | mA         |
| $I_L$             | Latching Current                       | $I_G = 1.2 I_{GT}, T_j = 25\text{ °C}$   | Q1,Q3    | MAX | 50          | 70   | mA         |
|                   |  |  | Q2       | MAX | 60          | 80   | mA         |
| $dV/dt^{(2)}$     | Critical Rate of Voltage Rise          | $V_D = 0.67 \times V_{DRM}, \text{Gate open}$<br>$T_j = 125\text{ °C}$   |          | MIN | 500         | 1000 | V/ $\mu$ s |
| $(dI/dt)^c^{(2)}$ | Critical Rate of Current Rise          | $(dv/dt)^c = 0.1\text{ V}/\mu\text{s}$ $T_j = 125\text{ °C}$<br>$(dv/dt)^c = 10\text{ V}/\mu\text{s}$ $T_j = 125\text{ °C}$<br>without snubber $T_j = 125\text{ °C}$ |          | MIN | -           | -    | A/ms       |
|                   |  |  |          | MIN | -           | -    |            |
|                   |  |  |          | MIN | 6.5         | 12   |            |
| $V_{TM}^{(2)}$    | On-state Voltage                       | $I_T = 17\text{ Amp}, t_p = 380\text{ }\mu\text{s}, T_j = 25\text{ °C}$  |          | MAX | 1.55        |      | V          |
| $V_{t(o)}^{(2)}$  | Threshold Voltage                      | $T_j = 125\text{ °C}$  |          | MAX | 0.85        |      | V          |
| $r_d^{(2)}$       | Dynamic resistance                     | $T_j = 125\text{ °C}$  |          | MAX | 35          |      | m $\Omega$ |
| $I_{DRM}/I_{RRM}$ | Off-State Leakage Current              | $V_D = V_{DRM}, T_j = 125\text{ °C}$<br>$V_R = V_{RRM}, T_j = 25\text{ °C}$  |          | MAX | 1           |      | mA         |
|                   |  |  |          | MAX | 5           |      | $\mu$ A    |
| $R_{th(j-c)}$     | Thermal Resistance<br>Junction-Case    | for AC 360° conduction angle   |          |     | 2.3         |      | °C/W       |
| $R_{th(j-a)}$     | Thermal Resistance<br>Junction-Ambient |  |          |     | 60          |      | °C/W       |

(1) Minimum  $I_{GT}$  is guaranteed at 5% of  $I_{GT}$  max.

(2) For either polarity of electrode MT2 voltage with reference to electrode MT1.

### Part Number Information



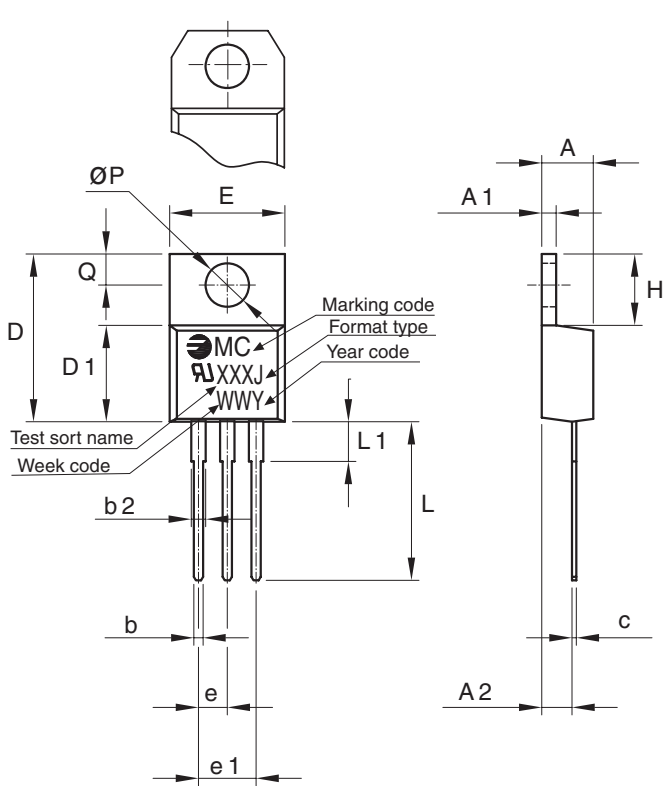
# INSULATED HIGH COMMUTATION TRIAC

## Ordering information

| PREFERRED P/N | PACKAGE CODE | DELIVERY MODE | BASE QUANTITY | UNIT WEIGHT (g) |
|---------------|--------------|---------------|---------------|-----------------|
| FT1214MJ 00TU | TU           | TUBE          | 1000          | 2.30            |

## Package Outline Dimensions: (mm) INSULATED TO-220AB

Optional with chamfer



| REF. | DIMENSIONS |       |
|------|------------|-------|
|      | Milimeters |       |
|      | Min.       | Max.  |
| A    | 4.32       | 4.62  |
| A1   | 1.21       | 1.29  |
| A2   | 2.40       | 2.70  |
| b    | 0.80       | 0.83  |
| b2   | 1.40       | --    |
| c    | 0.42       | 0.48  |
| D    | 15.5       | 15.68 |
| D1   | 9.26       | 9.42  |
| E    | 10.08      | 10.24 |
| e    | 2.54       | 2.54  |
| e1   | 5.08       | 5.08  |
| H1   | 6.24       | 6.26  |
| L    | 12.81      | 13.81 |
| L1   | 3.28       | 4.17  |
| P    | 3.70       | 3.80  |
| Q    | 2.75       | 2.85  |

Mounting Torque

0.8 N.m

**INSULATED HIGH COMMUTATION TRIAC**

**Ratings and Characteristics (Ta 25 °C unless otherwise noted)**

Fig. 1: Maximum power dissipation versus RMS on-state current (full cycle).

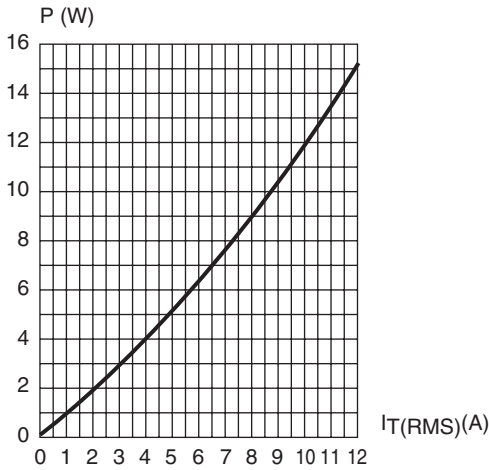


Fig. 2: RMS on-state current versus case temperature (full cycle).

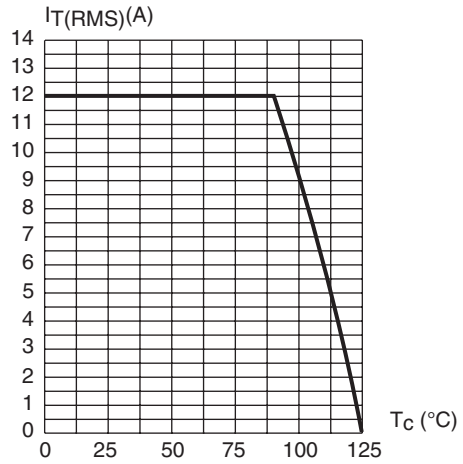


Fig. 3: Relative variation of thermal impedance versus pulse duration.

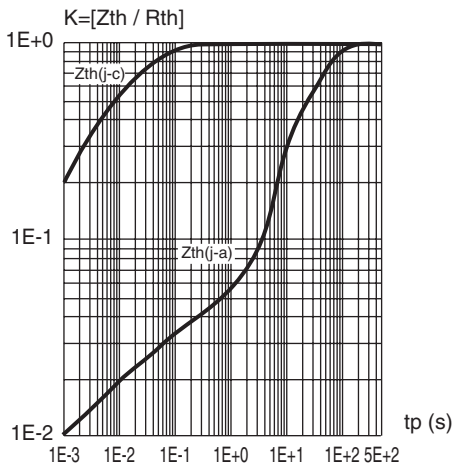


Fig. 4: On-state characteristics (maximum values)

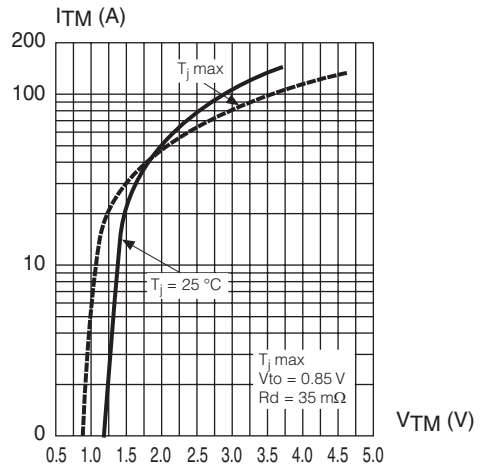


Fig. 5: Surge peak on-state current versus number of cycles

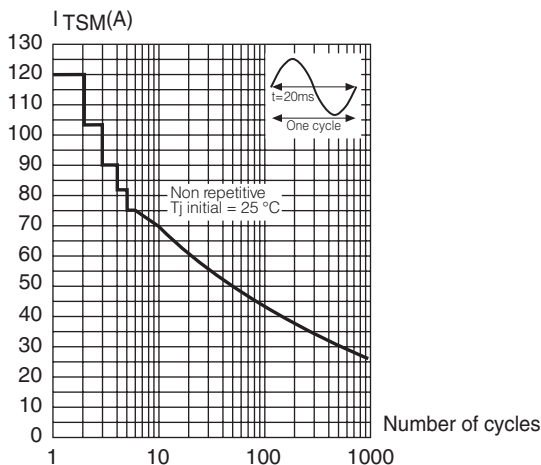
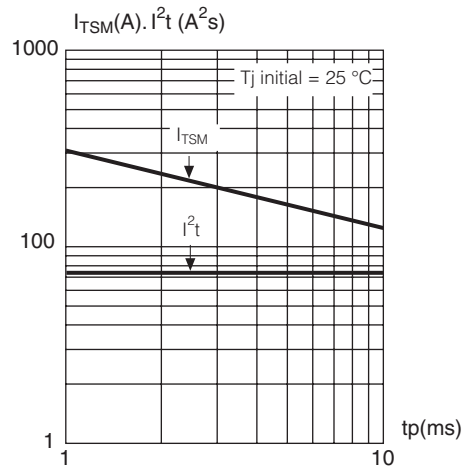


Fig. 6: Non repetitive surge peak on-state current for a sinusoidal pulse with width: tp < 10 ms, and corresponding value of I²t.



**INSULATED HIGH COMMUTATION TRIAC**

**Ratings and Characteristics (Ta 25 °C unless otherwise noted)**

Fig. 7: Relative variation of gate trigger current, holding current and latching versus junction temperature (typical values)

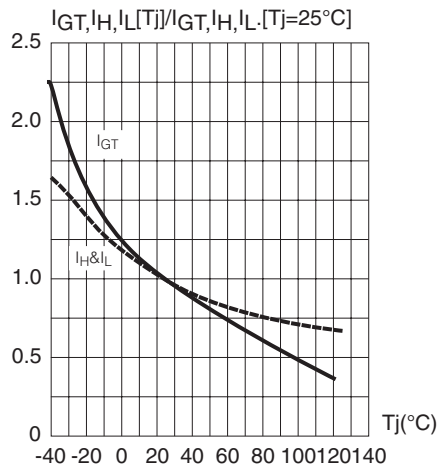
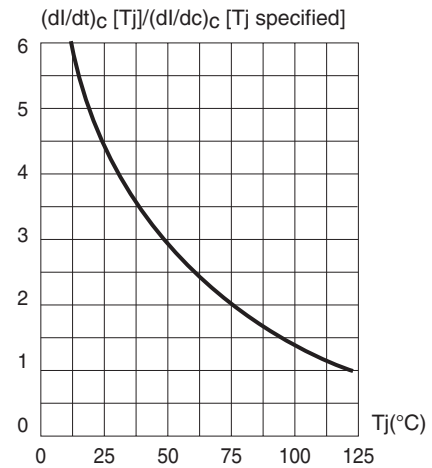


Fig. 8: Relative variation of critical rate of decrease of main current versus junction temperature



**INSULATED HIGH COMMUTATION TRIAC****Revision History**

| Date        | Revision | Description of Changes |
|-------------|----------|------------------------|
| Nov-2012    | 0        | Original Data Sheet    |
| 05-Jul-2017 | 1        | 200V eliminated        |

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